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- 53. The piezoelectric/electrostrictive film element in Claim 39, wherein said organic solvent which is a base of said ceramic sol solution is acetic acid, dimethyl formamide, methoxyethanol, alcohols, or glycols.
- 54. The piezoelectric/electrostrictive film element in Claim 39, wherein the content of said ceramic sol solution is 1-500 parts by weight based on the weight of said ceramic oxide powder when the suspension of said ultrafine ceramic oxide powder and said ceramic sol solution are mixed.
- 55. The piezoelectric/electrostrictive film element in Claim 39, wherein the thickness of said piezoelectric/electrostrictive film element is 1-100 $\mu \rm m$.
- 56. The piezoelectric/electrostrictive film element in Claim 55, wherein the thickness of said piezoelectric/electrostrictive film element is 5-30 μm .
- 57. The piezoelectric/electrostrictive film element in Claim 39, wherein said piezoelectric/electrostrictive film element is thermally thermaled at $150-300\,^{\circ}\text{C}$.